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PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

TECHNOLOGY CENTER 2800

FEB 19 2003

RECEIVED

Applicant: Shinji Isokawa Examiner: Wai Sing Lou  
Serial No.: 09/731,889 Group Art Unit: 2814  
Confirmation No.: 1026 Docket No.: 362-51 RCE  
Filed: December 7, 2000 Dated: February 13, 2003  
For: CHIP-TYPE SEMICONDUCTOR LIGHT-EMITTING DEVICE Customer No.: 33769

Commissioner for Patents  
Washington, DC 20231

*I hereby certify this correspondence is being deposited with the United States Postal Service "EXPRESS MAIL POST OFFICE TO ADDRESSEE" service under 37 C.F.R. 1.10 in an envelope addressed to: The Commissioner for Patents, Washington, D.C. 20231-0001*

On February 13, 2003

Signature:

Susan L. Toledano

**AMENDMENT**

Sir:

In response to the final Office Action dated August 14, 2002, please amend the above-identified application as follows:

**IN THE CLAIMS:**

Please amend Claim 1 by rewriting the same as follows:

1. (Twice Amended) A chip-type semiconductor light-emitting device, comprising:

a pair of electrodes, at least one of said pair of electrodes including an inner portion and an outer portion, the inner portion of the at least one of said pair of electrodes residing in the same plane as the outer portion of the at least one of said pair of electrodes;

a semiconductor light-emitting chip electrically connected to said pair of electrodes;